

October 1987 Revised June 2001

MM88C29 • MM88C30 **Quad Single-Ended Line Driver • Dual Differential Line Driver**

General Description

The MM88C30 is a dual differential line driver that also performs the dual four-input NAND or dual four-input AND function. The absence of a clamp diode to $V_{\mbox{\footnotesize CC}}$ in the input protection circuitry of the MM88C30 allows a CMOS user to interface systems operating at different voltage levels. Thus, a CMOS digital signal source can operate at a V_{CC} voltage greater than the $V_{\mbox{\footnotesize CC}}$ voltage of the MM88C30 line driver. The differential output of the MM88C30 eliminates ground-loop errors.

The MM88C29 is a non-inverting single-wire transmission line driver. Since the output ON resistance is a low 20Ω typ., the device can be used to drive lamps, relays, solenoids, and clock lines, besides driving data lines.

Features

■ Wide supply voltage range: 3V to 15V ■ High noise immunity: 0.45 V_{CC} (typ.)

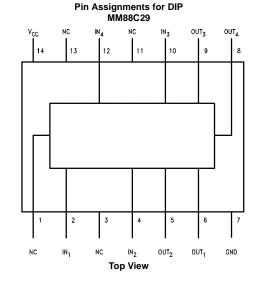
■ Low output ON resistance: 20Ω (typ.)

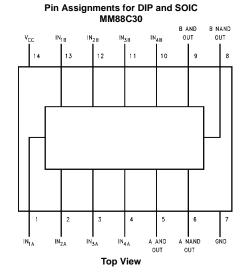
Ordering Code:

Order Number	Package Number	Package Description
MM88C29N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
MM88C30M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM88C30N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code

Connection Diagrams





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DS005908

Absolute Maximum Ratings(Note 1)

 $\begin{array}{lll} \mbox{Voltage at Any Pin (Note 2)} & -0.3 \mbox{V to V}_{\mbox{CC}} + 16 \mbox{V} \\ \mbox{Operating Temperature Range} & -40 \mbox{°C to } + 85 \mbox{°C} \\ \mbox{Storage Temperature} & -65 \mbox{°C to } + 150 \mbox{°C} \\ \end{array}$

Power Dissipation (P_D)

 $\begin{array}{cc} \text{Dual-In-Line} & 700 \text{ mW} \\ \text{Small Outline} & 500 \text{ mW} \\ \text{Operating V}_{\text{CC}} \text{ Range} & 3\text{V to 15V} \\ \text{Absolute Maximum V}_{\text{CC}} & 18\text{V} \\ \end{array}$

Average Current at Output

 $\begin{array}{lll} \text{MM88C30} & \text{50 mA} \\ \text{MM88C29} & \text{25 mA} \\ \text{Maximum Junction Temperature, T}_{j} & \text{150}^{\circ}\text{C} \\ \end{array}$

Lead Temperature

(Soldering, 10 seconds) 260°C

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The Electrical Characteristics tables provide conditions for actual device operation.

Note 2: AC Parameters are guaranteed by DC correlated testing.

DC Electrical Characteristics

Min/Max limits apply across temperature range unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
CMOS TO	CMOS		*	•		•
V _{IN(1)}	Logical "1" Input Voltage	V _{CC} = 5V	3.5			V
		V _{CC} = 10V	8			V
V _{IN(0)}	Logical "0" Input Voltage	V _{CC} = 5V			1.5	V
		V _{CC} = 10V			2	V
I _{IN(1)}	Logical "1" Input Current	V _{CC} = 15V, V _{IN} = 15V		0.005	1	μΑ
I _{IN(0)}	Logical "0" Input Current	V _{CC} = 15V, V _{IN} = 0V	-1	-0.005		μΑ
I _{CC}	Supply Current	V _{CC} = 5V		0.05	100	mA
OUTPUT [DRIVE		•			
I _{SOURCE}	Output Source Current	$V_{OUT} = V_{CC} - 1.6V,$				
		$V_{CC} \ge 4.75V, T_j = 25^{\circ}C$	-47	-80		mA
		T _i = 85°C	-32	-60		mA
	MM88C29	$V_{OUT} = V_{CC} - 0.8V$	-2	-20		mA
	MM88C30	V _{CC} ≥ 4.5V				
I _{SINK}	Output Sink Current	$V_{OUT} = 0.4V, V_{CC} = 4.75V,$				
		T _j = 25°C	9.5	22		mA
		T _i = 85°C	8	18		mA
		$V_{OUT} = 0.4V, V_{CC} = 10V,$				
		T _j = 25°C	19	40		mA
		T _j = 125°C	15.5	33		mA
I _{SOURCE}	Output Source Resistance	$V_{OUT} = V_{CC} - 1.6V,$				
		$V_{CC} \ge 4.75V, T_j = 25^{\circ}C$		20	34	Ω
		T _j = 85°C		27	50	Ω
I _{SINK}	Output Sink Resistance	V _{OUT} = 0.4V, V _{CC} = 4.75V,				
		$T_j = 25^{\circ}C$		18	41	Ω
		T _j = 85°C		22	50	Ω
		V _{OUT} = 0.4V, V _{CC} = 10V,				
		T _i = 25°C		10	21	Ω
		T _i = 85°C		12	26	Ω
	Output Resistance					
	Temperature Coefficient					
	Source			0.55		%/°C
	Sink			0.40		%/°C
θ_{JA}	Thermal Resistance			150		°C/W
	(N-Package)					

AC Electrical Characteristics (Note 2)

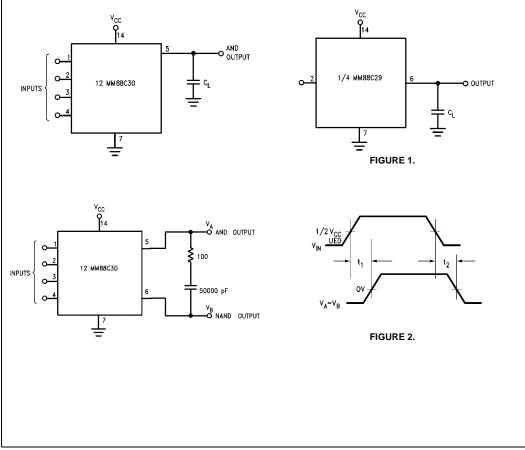
 $T_A=25^{\circ}C,\ C_L=50\ pF$

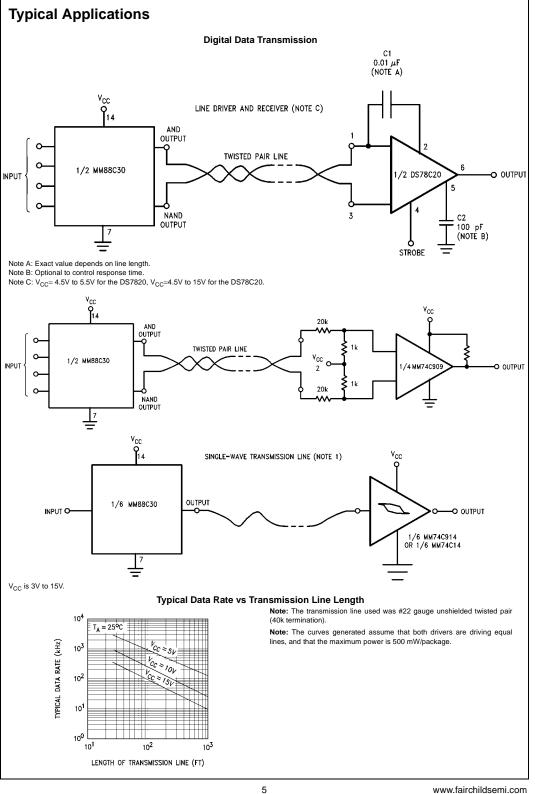
Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{pd}	Propagation Delay Time to					
	Logical "1" or "0"	(See Figure 1)				
	MM88C29	$V_{CC} = 5V$		80	200	ns
		V _{CC} = 10V		35	100	ns
	MM88C30	V _{CC} = 5V		110	350	ns
		$V_{CC} = 10V$		50	150	ns
t _{pd}	Differential Propagation Delay	$R_L = 100\Omega, C_L = 5000 pF$				
	Time to Logical "1" or "0"	(See Figure 2)				
	MM88C30	$V_{CC} = 5V$			400	ns
		V _{CC} = 10V			150	ns
C _{IN}	Input Capacitance					
	MM88C29	(Note 3)		5.0		pF
	MM88C30	(Note 3)		5.0		pF
C _{PD}	Power Dissipation Capacitance					
	MM88C29	(Note 3)		150		pF
	MM88C30	(Note 3)		200		pF

Note 3: Capacitance is guaranteed by periodic testing.

Note 4: C_{PD} determines the no load AC power consumption of any CMOS device. For complete explanation see Family Characteristics application note AN-90 (CMOS Logic Databook).

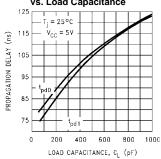
AC Test Circuits



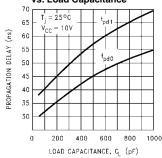


Typical Performance Characteristics

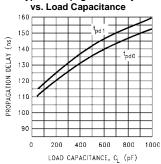
MM88C29 Typical Propagation Delay vs. Load Capacitance



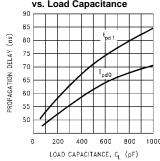
MM88C29
Typical Propagation Delay vs. Load Capacitance



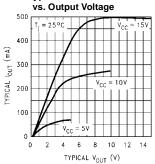
MM88C30 Typical Propagation Delay



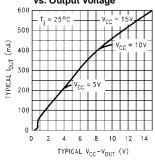
MM88C30 Typical Propagation Delay vs. Load Capacitance

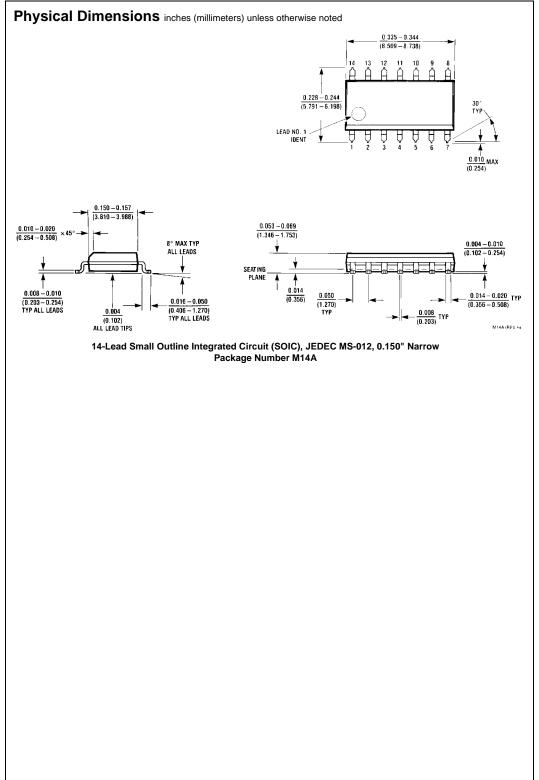


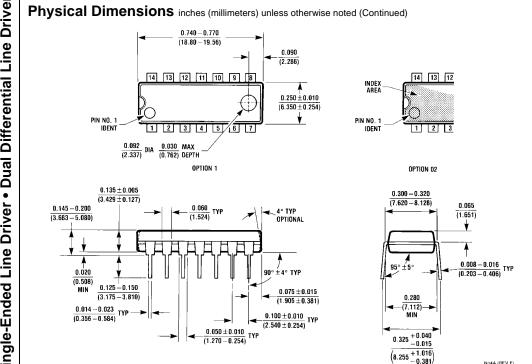
Typical Sink Current



Typical Source Current vs. Output Voltage







14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

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